



MC15N007

主要参数 MAIN CHARACTERISTICS

I_D	100A
V_{DSS}	150V
$R_{dson-typ}$ (@ $V_{gs}=10V$)	5.9m Ω
Q_g-typ	120nC

用途

- 电信与工业领域隔离 DC/DC 转换
- 同步整流领域 DC/DC 与 AC/DC 转换

产品特性

- 低栅极电荷
- 低 R_{dson}
- 开关速度快
- 产品全部经过雪崩测试
- 高抗 dv/dt 能力
- RoHS 产品

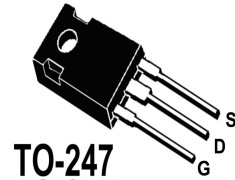
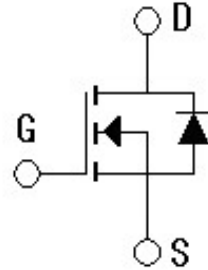
APPLICATIONS

- Isolated DC/DC Converters in Telecom and Industrial
- Synchronous Rectification in DC/DC and AC/DC Converters

FEATURES

- Low gate charge
- Low R_{dson}
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS product

封装 Package



订货信息 ORDER MESSAGE

订货型号 Order codes				印 记 Marking	封 装 Package
有卤-条管 Halogen-Tube	无卤-条管 Halogen-Free-Tube	有卤-编带 Halogen-Reel	无卤-编带 Halogen-Free-Reel		
MC15N007-GE-B	MC15N007-GE-BR	N/A	N/A	MC15N007	TO-247



绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项 目 Parameter	符 号 Symbol	数 值 Value	单 位 Unit
		MC15N007	
最高漏极-源极直流电压 Drain-Source Voltage	V _{DSS}	150	V
连续漏极电流 Drain Current -continuous	I _D T=25°C	100*	A
	I _D T=100°C	93*	A
最大脉冲漏极电流 (注1) Drain Current - pulse (note 1)	I _{DM}	400*	A
最高栅源电压 Gate-Source Voltage	V _{GSS}	±20	V
单脉冲雪崩能量 (注2) Single Pulsed Avalanche Energy (note 2)	E _{AS}	380	mJ
耗散功率 Power Dissipation	P _D T _C =25°C -Derate above 25°C	315	W
		2.1	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	T _J , T _{STG}	-55~+150	°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T _L	300	°C

*漏极电流由最高结温限制

*Drain current limited by maximum junction temperature



电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单 位 Units
关态特性 Off –Characteristics						
漏—源击穿电压 Drain-Source Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	150	-	-	V
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=150V, V_{GS}=0V,$ $T_C=25^\circ C$	-	-	10	μA
正向栅极体漏电流 Gate-body leakage current, forward	I_{GSSF}	$V_{DS}=0V, V_{GS}=20V$	-	-	100	nA
反向栅极体漏电流 Gate-body leakage current, reverse	I_{GSSR}	$V_{DS}=0V, V_{GS}=-20V$	-	-	-100	nA
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D=250\mu A$	2	3	4	V
静态导通电阻 Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D=100A$	-	5.9	7.2	m Ω
正向跨导 Forward Transconductance	g_{fs}	$V_{DS} = 2V, I_D=20A$ (note 4)	-	79	-	S
动态特性 Dynamic Characteristics						
栅电阻 Gate resistance	R_g	$f=1.0MHz, open\ drain$	-	2.9	-	Ω
输入电容 Input capacitance	C_{iss}	$V_{DS}=75V,$ $V_{GS}=0V,$ $f=1.0MHz$	-	9108	-	pF
输出电容 Output capacitance	C_{oss}		-	612	-	pF
反向传输电容 Reverse transfer capacitance	C_{rss}		-	18	-	pF

**电特性 ELECTRICAL CHARACTERISTICS**

开关特性 Switching Characteristics					
延迟时间 Turn-On delay time	$t_{d(on)}$	$V_{DD}=75V, V_{GS}=10V$ $I_D=100A, R_G=1.6\Omega$, (note 3, 4)	-	26	- ns
上升时间 Turn-On rise time	t_r		-	114	- ns
延迟时间 Turn-Off delay time	$t_{d(off)}$		-	61	- ns
下降时间 Turn-Off Fall time	t_f		-	29	- ns
栅极电荷总量 Total Gate Charge	Q_g	$V_{DS}=75V, V_{GS}=10V$ $I_D=100A$ (note 3, 4)	-	120	- nC
栅-源电荷 Gate-Source charge	Q_{gs}		-	58	- nC
栅-漏电荷 Gate-Drain charge	Q_{gd}		-	12	- nC
漏-源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings					
正向最大连续电流 Maximum Continuous Drain-Source Diode Forward Current	I_S	$T_C=25^\circ C$	-	-	100 A
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}	$T_C=25^\circ C$	-	-	400 A
正向压降 Drain-Source Diode Forward Voltage	V_{SD}	$T_J=25^\circ C, V_{GS}=0V, I_{SD}=50A$	-	0.9	1.4 V
反向恢复时间 Reverse recovery time	T_{rr}	$V_{GS}=0V, I_S=100A$ $dI_F/dt=100A/\mu s$ (note 4)		110	ns
反向恢复电荷 Reverse recovery charge	Q_{rr}			410	nc

热特性 THERMAL CHARACTERISTIC

项 目 Parameter	符 号 Symbol	最大 Max	单 位 Unit
		MC15N007	
结到管壳的热阻 Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.302	$^\circ C/W$
结到环境的热阻 Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	32.91	$^\circ C/W$

注释:

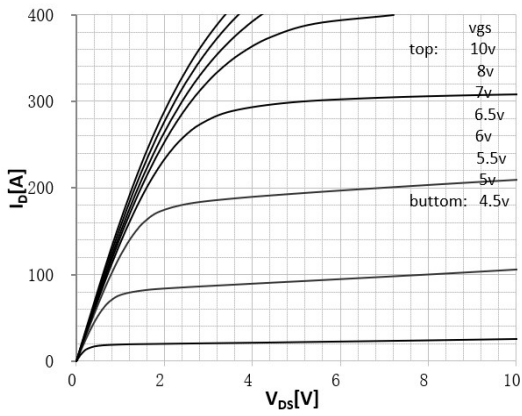
- 1: 脉冲宽度由最高结温限制
- 2: $V_{DD}=100V, V_{GS}=10V, L=0.5mH, R_G=25\Omega$, 起始结温 $T_J=25^\circ C$
- 3: 脉冲测试: 脉冲宽度 $\leq 300\mu s$, 占空比 $\leq 2\%$
- 4: 基本与工作温度无关

Notes:

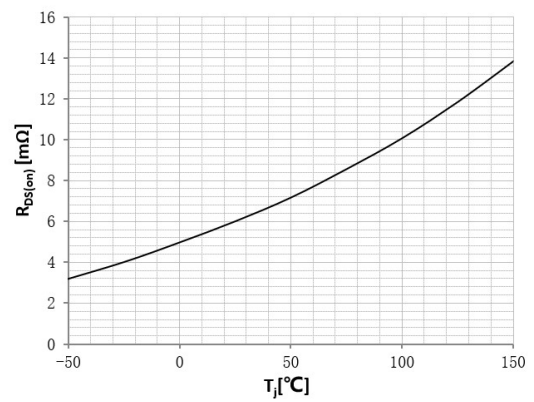
- 1: Pulse width limited by maximum junction temperature
- 2: $V_{DD}=100V, V_{GS}=10V, L=0.5mH, R_G=25\Omega$, Starting $T_J=25^\circ C$
- 3: Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$
- 4: Essentially independent of operating temperature



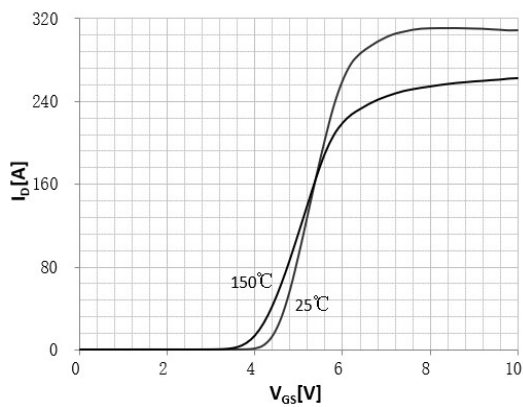
On-Region Characteristics



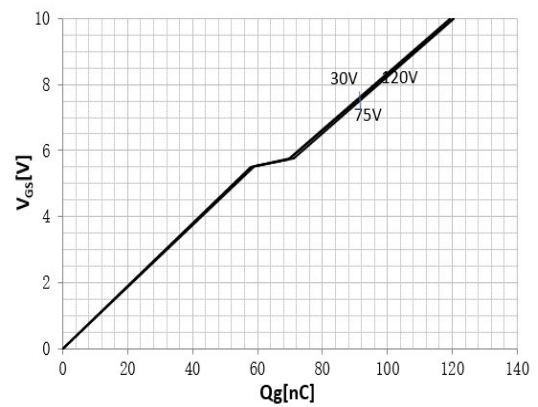
$R_{DS(on)}$ vs. T_J



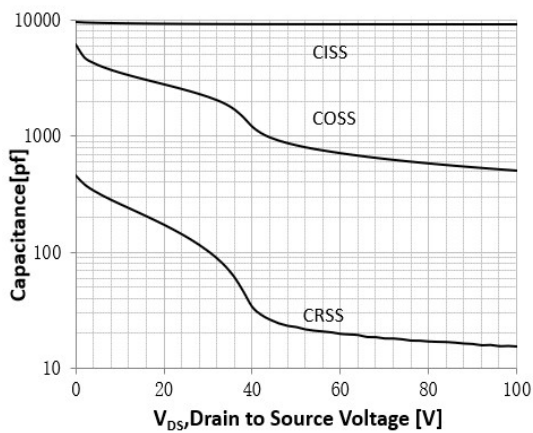
Transfer Characteristics



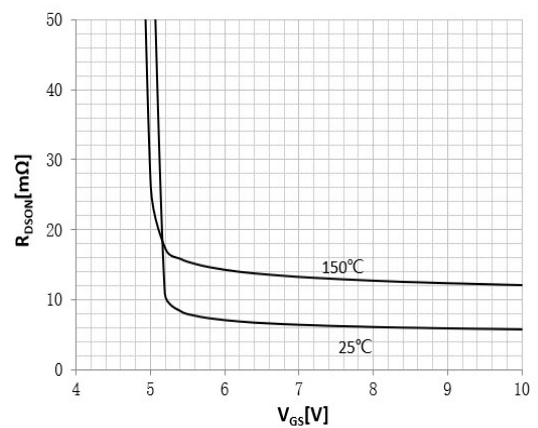
Gate Charge Characteristics



Capacitance Characteristics

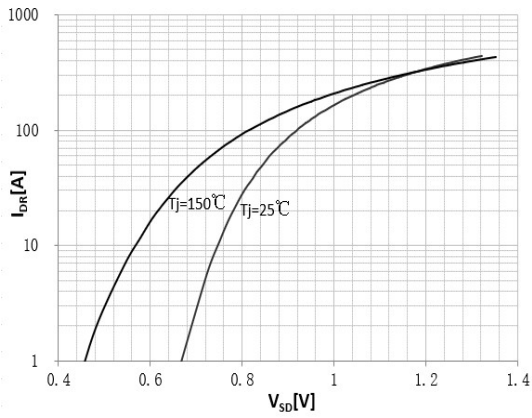


Drain-Source on resistance

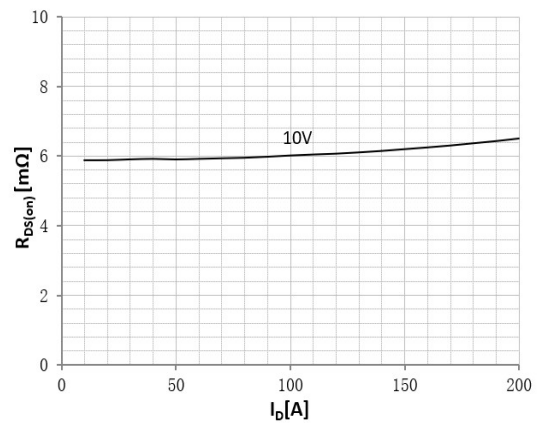




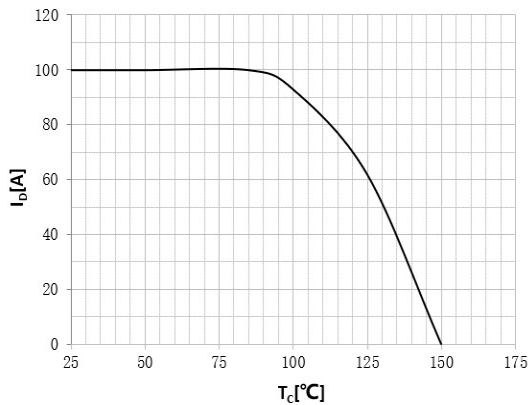
Body Diode Forward Voltage Variation vs. Source Current and Temperature



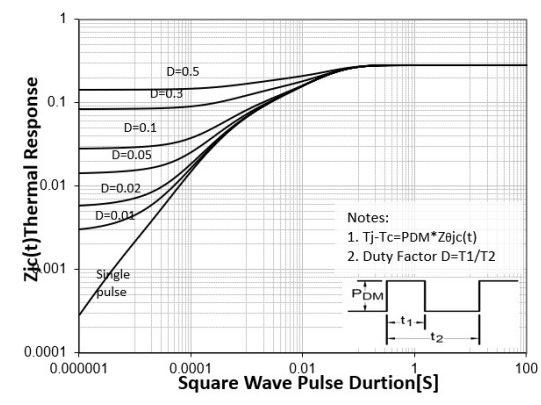
On-Resistance Variaton vs. Drain Current and Gate Voltage



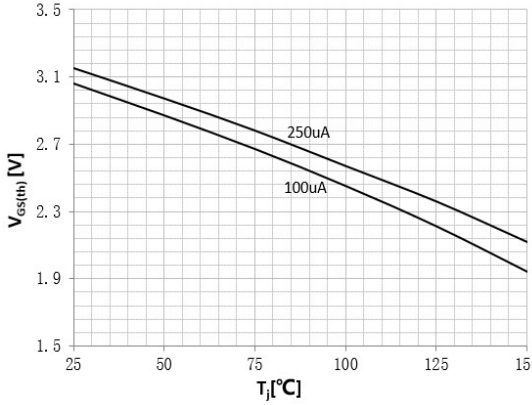
Drain Current Dissipation vs Tc



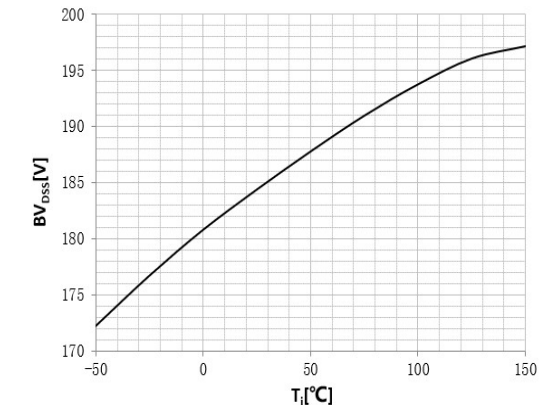
Transient Thermal Impedance



Gate Threshold Voltage Variation vs Tj

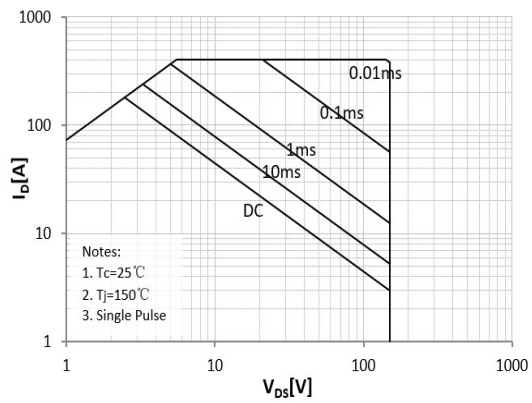


Breakdown Voltage Variation vs Tj





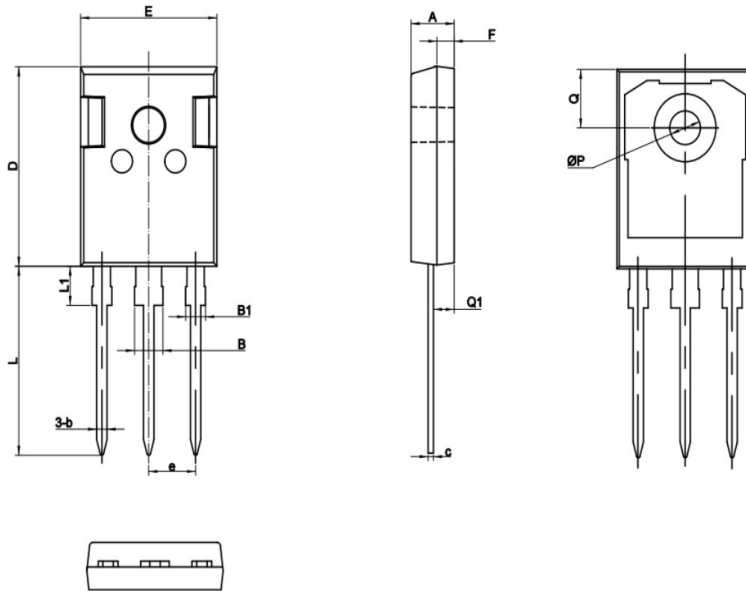
Maximum Safe Operation





TO-247

单位 Unit: mm



符号 symbol	mm	
	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L1	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70



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